AUTOMOTIVE GRADE

Available

COMPLIANT

HALOGEN

FREE



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Vishay General Semiconductor

High Current Density Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low $V_F = 0.44 \text{ V}$ at $I_F = 2.5 \text{ A}$



DESIGN SUPPORT TOOLS AVAILABLE



| PRIMARY CHARACTERISTICS | | | | |
|--|----------------|--|--|--|
| I _{F(AV)} | 2 x 5 A | | | |
| V_{RRM} | 100 V | | | |
| I _{FSM} | 100 A | | | |
| V_F at $I_F = 5$ A ($T_A = 125$ °C) | 0.55 V | | | |
| T _J max. | 150 °C | | | |
| Package | FlatPAK 5 x 6 | | | |
| Circuit configuration | Common cathode | | | |

FEATURES

- Trench MOS Schottky technology
- · Low forward voltage drop, low power losses
- · High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C



- Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



For use in low voltage high frequency DC/DC converters, freewheeling diodes, and polarity protection applications.

MECHANICAL DATA

Case: FlatPAK 5 x 6

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

| MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted) | | | | | |
|--|-------------------------------|-------------|------|--|--|
| PARAMETER | SYMBOL | V10K100C | UNIT | | |
| Device marking code | | V1010C | | | |
| Maximum repetitive peak reverse voltage | V_{RRM} | 100 | V | | |
| Maximum DC forward current per device | I _{F(AV)} (1) | 10 | А | | |
| | I _{F(AV)} (2) | 3.9 | А | | |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load per diode | I _{FSM} | 100 | А | | |
| Operating junction temperature range | T _J ⁽³⁾ | -40 to +150 | °C | | |
| Storage temperature range | T _{STG} | -55 to +150 | °C | | |

Notes

- (1) With infinite heatsink
- (2) Free air, mounted on recommended pad area
- $^{(3)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$



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| ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | |
|--|--|-------------------------|-------------------------------|------|------|------|
| PARAMETER | TEST CONDITIONS | | SYMBOL | TYP. | MAX. | UNIT |
| | I _F = 2.5 A | T _A = 25 °C | V _F ⁽¹⁾ | 0.5 | - | V |
| Instantance is feminard voltage may diede | I _F = 5 A | | | 0.61 | 0.69 | |
| Instantaneous forward voltage per diode | I _F = 2.5 A | T _A = 125 °C | | 0.44 | - | |
| | I _F = 5 A | | | 0.55 | 0.63 | |
| | $V_{R} = 70 \text{ V} \qquad \frac{T_{A} = 25 \text{ °C}}{T_{A} = 125 \text{ °C}}$ $V_{R} = 100 \text{ V} \qquad \frac{T_{A} = 25 \text{ °C}}{T_{A} = 125 \text{ °C}}$ | T _A = 25 °C | I _B ⁽²⁾ | 0.01 | - | mA |
| Deverage augment new devices | | T _A = 125 °C | | 3 | - | |
| Reverse current per device | | IR (=) | - | 0.4 | IIIA | |
| | | T _A = 125 °C | | 6 | 16 | |
| Typical junction capacitance per diode | 4.0 V, 1 MHz | | CJ | 620 | - | pF |

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 5 ms

| THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | |
|---|--------------------------|------|------|------|--|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT | |
| Thermal registence per device | R ₀ JA (1)(2) | 75 | - | °C/W | |
| Thermal resistance per device | R _{0JM} (3) | 2.5 | 3.5 |] | |

Notes

- $^{(1)}$ The heat generated must be less than thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$
- $^{(2)}$ Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ junction-to-ambient
- $^{(3)}$ Mounted on infinite heat sink; thermal resistance $R_{\theta JM}$ junction-to-mount

| ORDERING INF | ORDERING INFORMATION (Example) | | | | | |
|-------------------|--------------------------------|------------------------|---------------|------------------------------------|--|--|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE | | |
| V10K100C-M3/H | 0.10 | Н | 1500 | 7" diameter plastic tape and reel | | |
| V10K100C-M3/I | 0.10 | 1 | 6000 | 13" diameter plastic tape and reel | | |
| V10K100CHM3/H (1) | 0.10 | Н | 1500 | 7" diameter plastic tape and reel | | |
| V10K100CHM3/I (1) | 0.10 | 1 | 6000 | 13" diameter plastic tape and reel | | |

Note

(1) AEC-Q101 qualified

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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

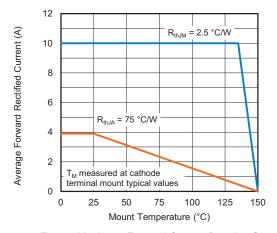


Fig. 1 - Maximum Forward Current Derating Curve

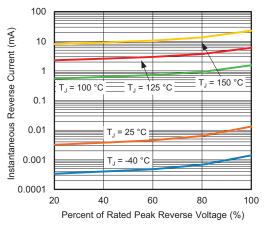


Fig. 4 - Typical Reverse Leakage Characteristics

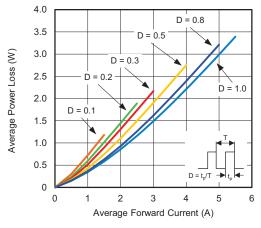


Fig. 2 - Forward Power Loss Characteristics

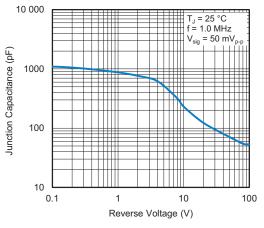


Fig. 5 - Typical Junction Capacitance

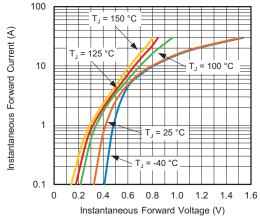


Fig. 3 - Typical Instantaneous Forward Characteristics

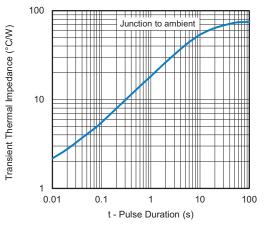


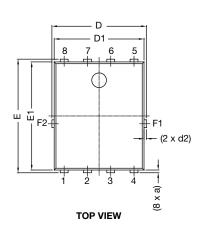
Fig. 6 - Typical Transient Thermal Impedance

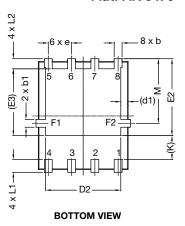


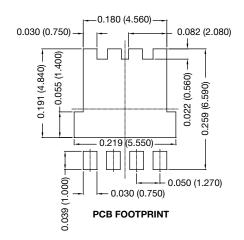
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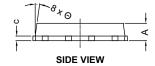
PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

FlatPAK 5 x 6









| DIM | | INCHES | | | MILLIMETERS | |
|------|-------|-----------|-------|------|-------------|------|
| DIM. | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. |
| Α | 0.035 | 0.039 | 0.043 | 0.89 | 0.99 | 1.09 |
| (a) | - | 0.006 | - | - | 0.15 | - |
| b | 0.013 | 0.017 | 0.020 | 0.32 | 0.43 | 0.52 |
| b1 | 0.013 | 0.017 | 0.020 | 0.32 | 0.43 | 0.52 |
| С | 0.008 | - | 0.014 | 0.20 | - | 0.35 |
| D | 0.197 | 0.203 | 0.209 | 5.00 | 5.15 | 5.30 |
| D1 | 0.189 | 0.193 | 0.197 | 4.80 | 4.90 | 5.00 |
| D2 | 0.154 | 0.161 | 0.169 | 3.90 | 4.10 | 4.30 |
| (d1) | - | 0.016 | - | - | 0.40 | - |
| (d2) | - | 0.005 | - | - | 0.125 | - |
| Е | 0.238 | 0.244 | 0.250 | 6.05 | 6.20 | 6.35 |
| E1 | 0.228 | 0.232 | 0.236 | 5.80 | 5.90 | 6.00 |
| E2 | 0.157 | 0.165 | 0.173 | 4.00 | 4.20 | 4.40 |
| (E3) | - | 0.144 | - | - | 3.65 | = |
| е | | 0.050 BSC | | | 1.27 BSC | |
| (K) | 0.039 | - | - | 1.00 | - | - |
| L1 | 0.019 | - | 0.043 | 0.48 | - | 1.10 |
| L2 | 0.012 | - | 0.031 | 0.30 | - | 0.80 |
| М | 0.128 | 0.138 | 0.148 | 3.25 | 3.50 | 3.75 |
| Θ | 0° | - | 10° | 0° | - | 10° |

Notes

- Dimensioning and tolerancing per ASME Y14.5-2009
- Dimensions D1 and E1 do not include mold flash or gate burrs
- Dimension (XX) means reference only



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